

PR29MF1xNSZ Series PR39MF1xNSZ Series PR49MF11NSZ Series

*Zero cross type is also available. (PR29MF2xNSZ Series/PR39MF2xNSZ Series)

I_T(rms)≤0.9A, Non-Zero Cross type DIP 8pin Triac output SSR



■ Description

PR29MF1xNSZ Series, PR39MF1xNSZ Series and PR49MF11NSZ Series Solid State Relays (SSR) are an integration of an infrared emitting diode (IRED), a Phototriac Detector and a main output Triac. These devices are ideally suited for controlling high voltage AC loads with solid state reliability while providing 4.0kV isolation ($V_{iso}(rms)$) from input to output.

■ Features

- 1. Output current, I_T(rms)≤0.9A
- 2. Non-zero crossing functionary
- 3. 8 pin DIP package (SMT gullwing also available)
- 4. High repetitive peak off-state voltage

 $(V_{DRM}: 800V, PR49MF11NSZ Series)$

(V_{DRM}: 600V, PR39MF1xNSZ Series)

(V_{DRM}: 400V, PR29MF1xNSZ Series)

- 5. I_{FT} ranks available (see Model Line-up in this datasheet)
- 6. Superior noise immunity

 $(dV/dt: MIN. 100V/\mu s, PR29MF1xNSZ Series and PR39MF1xNSZ Series)$

(dV/dt : MIN. 50V/μs, PR49MF11NSZ Series)

- 7. Response time, ton: MAX. 100μs
- 8. Lead-free terminal components are also available (see Model Line-up section in this datasheet)
- High isolation voltage between input and output (V_{iso}(rms): 4.0kV)

■ Agency approvals/Compliance

- Recognized by UL508 (except for PR49MF11NSZ Series), file No. E94758 (as model No. R29MF1/ R39MF1)
- Approved by CSA 22.2 No.14 (except for PR49MF11NSZ Series), file No. LR63705 (as model No. R29MF1/R39MF1)
- Optionary available VDE approved (*)(DIN EN 60747-5-2), file No.40008898 (only for PR39MF1xNSZ Series as model No. R39MF1)
- 4. Package resin: UL flammability grade (94V-0)
 - (*) DIN EN60747-5-2: successor standard of DIN VDE0884. Up to Date code "RD" (December 2003), approval of DIN VDE0884.

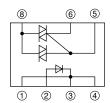
From Date code "S1" (January 2004), approval of DIN EN60747-5-2.

■ Applications

- 1. Isolated interface between high voltage AC devices and lower voltage DC control circuitry.
- 2. Switching motors, fans, heaters, solenoids, and valves.
- 3. Phase or power control in applications such as lighting and temperature control equipment.



■ Internal Connection Diagram

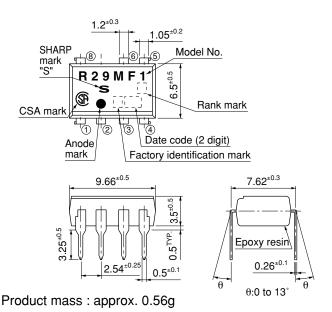


- ① Cathode ⑤ Gate
- 3 Cathode 8 Output (T₂)
- ④ Cathode

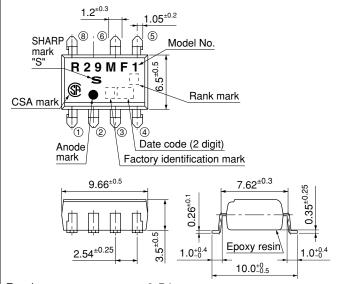
■ Outline Dimensions

(Unit: mm)

1. Through-Hole [ex. **PR29MF11NSZF**]

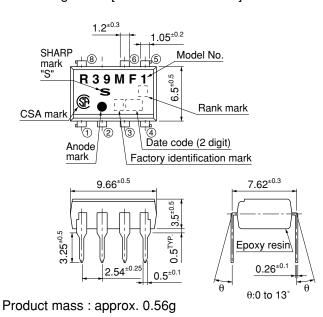


2. SMT Gullwing Lead-Form [ex. PR29MF11NIPF]

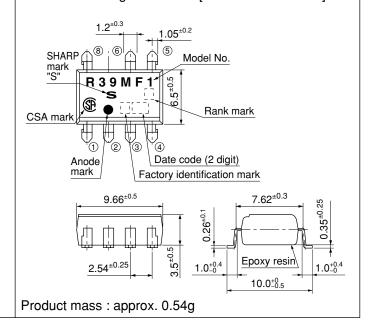


Product mass: approx. 0.54g

3. Through-Hole [ex. PR39MF11NSZF]



4. SMT Gullwing Lead-Form [ex. PR39MF11NIPF]



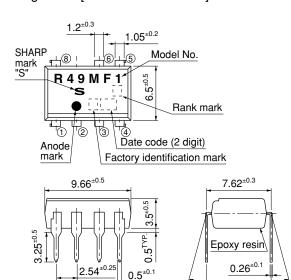
Sheet No.: D4-A00601EN

Product mass: approx. 0.54g



Outline Dimensions (Unit: mm)

5. Through-Hole [ex. PR49MF11NSZF]



 θ :0 to 13°

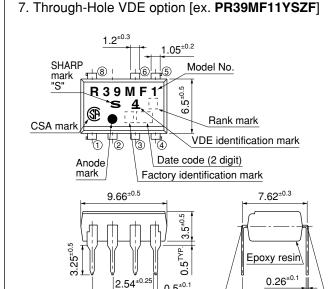
 θ :0 to 13°

Product mass: approx. 0.56g

6. SMT Gullwing Lead-Form [ex. PR49MF11NIPF] 1.05^{±0.2} **SHARP** Model No. mark "S" R 49 Rank mark Date code (2 digit) Anode mark Factory identification mark $7.62^{\pm0.3}$ $9.66^{\pm0.5}$ 0.35±0.25 $.26^{\pm0.1}$ Epoxy resin 2.54^{±0.25} $1.0^{+0.4}_{-0}$ $1.0^{+0.4}_{-0}$

8. SMT Gullwing Lead-Form VDE option [ex. PR39MF11YIPF]

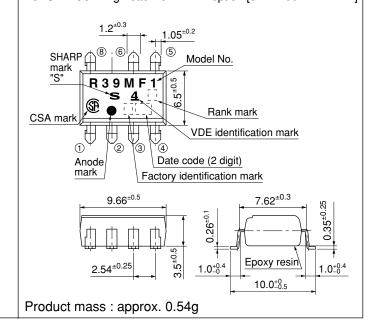
10.0+0.5



 $0.5^{\pm0.1}$

 $2.54^{\pm0.25}$

Product mass: approx. 0.56g





Date code (2 digit)

| | 1st o | digit | | 2nd digit | | |
|------|-----------|-----------|------|---------------------|------|--|
| | Year of p | roduction | | Month of production | | |
| A.D. | Mark | A.D | Mark | Month | Mark | |
| 1990 | A | 2002 | P | January | 1 | |
| 1991 | В | 2003 | R | February | 2 | |
| 1992 | С | 2004 | S | March | 3 | |
| 1993 | D | 2005 | T | April | 4 | |
| 1994 | Е | 2006 | U | May | 5 | |
| 1995 | F | 2007 | V | June | 6 | |
| 1996 | Н | 2008 | W | July | 7 | |
| 1997 | J | 2009 | X | August | 8 | |
| 1998 | K | 2010 | A | September | 9 | |
| 1999 | L | 2011 | В | October | 0 | |
| 2000 | M | 2012 | С | November | N | |
| 2001 | N | : | : | December | D | |

repeats in a 20 year cycle

Factory identification mark

| Factory identification Mark | Country of origin | | |
|-----------------------------|-------------------|--|--|
| no mark | Ionon | | |
| | Japan | | |

^{*} This factory marking is for identification purpose only.

Please contact the local SHARP sales representative to see the actural status of the production.

Rank mark

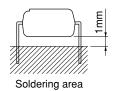
Please refer to the Model Line-up table.



■ Absolute Maximum Ratings

 $(T_a=25^{\circ}C)$

| | (1a 25 C) | | | | | | | | |
|-------------|-------------------|------------------------|----------------------|--------|----|--|--|--|--|
| | Parameter | Symbol | Rating | Unit | | | | | |
| т , | Forward current | | I_F | 50 *3 | mA | | | | |
| Input | Reverse voltage | | V _R | 6 | V | | | | |
| | RMS ON-state cu | ırrent | I _T (rms) | 0.9 *3 | A | | | | |
| | Peak one cycle su | irge current | I _{surge} | 9 *4 | A | | | | |
| Output | Repetitive | PR29MF1xNSZ | | 400 | | | | | |
| | peak OFF-state | PR39MF1xNSZ | V_{DRM} | 600 | V | | | | |
| | voltage | PR49MF11NSZ | | 800 | | | | | |
| *1 Isolatio | n voltage | V _{iso} (rms) | 4.0 | kV | | | | | |
| Operati | ing temperature | Topr | -25 to +85 | °C | | | | | |
| Storage | temperature | T _{stg} | -40 to +125 | °C | | | | | |
| *2Solderi | ng temperature | | T _{sol} | 270 *5 | °C | | | | |



■ Electro-optical Characteristics

 $(T_a=25^{\circ}C)$

| | Parameter | | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|------------------|--|--------------|------------------|-----------------------------------|--------------------|-----------|------|------|
| | Forward voltage | | V_F | I _F =20mA | - | 1.2 | 1.4 | V |
| Input | Reverse current | | I_R | $V_R=3V$ | _ | _ | 10 | μΑ |
| | Repetitive peak OFF-s | tate current | I_{DRM} | $V_D = V_{DRM}$ | _ | _ | 100 | μΑ |
| | ON-state voltage | | V_{T} | $I_T=0.9A$ | _ | _ | 3.0 | V |
| | | PR29MF1xNSZ | | | _ | _ | 25 | |
| Output | Holding current | PR39MF1xNSZ | I_H | $V_D=6V$ | _ | _ | 23 | mA |
| Output | | PR49MF11NSZ | 1 | | - | _ | 50 | |
| | Critical rate of rise of OFF-state voltage | PR29MF1xNSZ | dV/dt | $V_D=1/\sqrt{2}\cdot V_{DRM}$ | 100 | _ | _ | V/µs |
| | | PR39MF1xNSZ | | | | _ | _ | |
| | | PR49MF11NSZ | | | 50 | _ | _ | |
| | Minimum tri agan ayan | Rank 1 | | $V_D=6V, R_L=100\Omega$ | - | _ | 10 | mA |
| Transfer charac- | Minimum trigger current Rank 2 | | - Ift | | - | _ | 5 | IIIA |
| | Isolation resistance | | R _{ISO} | DC500V,40 to 60%RH | 5×10 ¹⁰ | 10^{11} | _ | Ω |
| teristics | Turn-on time | Rank 1 | | $I_F=20mA, V_D=6V, R_L=100\Omega$ | | _ | 100 | μs |
| | Rank 2 | | t _{on} | $I_F=10mA, V_D=6V, R_L=100\Omega$ | _ | | | |

^{*1 40} to 60%RH, AC for 1minute, f=60Hz

^{*2} For 10s

^{*3} Refer to Fig.1, Fig.2

*4 f=50Hz sine wave

*5 Lead solder plating models : 260°C



■ Model Line-up (1) (Lead-free terminal components)

| Lead Form | Through-Hole | | SMT Gullwing | | | | |
|------------------|--------------|--------------|---------------|--------------|-----------|-----------|----------------------|
| G1: | | eve | Taping | | *** | | I _{FT} [mA] |
| Shipping Package | 50pcs/sleeve | | 1 000pcs/reel | | V_{DRM} | Rank mark | $(V_D=6V,$ |
| DIN | | | | | [V] | | $R_L=100\Omega$) |
| EN60747-5-2 | | Approved | —— Approved | | | | |
| | PR49MF11NSZF | | PR49MF11NIPF | | 800 | 1 | MAX.10 |
| | PR39MF11NSZF | PR39MF11YSZF | PR39MF11NIPF | PR39MF11YIPF | 600 | 1 | MAX.10 |
| Model No. | PR39MF12NSZF | PR39MF12YSZF | PR39MF12NIPF | PR39MF12YIPF | 600 | 2 | MAX.5 |
| | PR29MF11NSZF | | PR29MF11NIPF | | 400 | 1 | MAX.10 |
| | PR29MF12NSZF | | PR29MF12NIPF | | 400 | 2 | MAX.5 |

■ Model Line-up (2) (Lead solder plating components)

| Lead Form | Through-Hole | | SMT Gullwing | | | | | |
|--------------------|--|-------------|--------------|-----------|------------|---|----------------------|--|
| G1: : D 1 | Sleeve | | Taping | | *** | | I _{FT} [mA] | |
| Shipping Package | pping Package 50pcs/sleeve 1 000pcs/reel | | V_{DRM} | Rank mark | $(V_D=6V,$ | | | |
| DIN EN60747-5-2 | | Approved | —— Approved | | [V] | | $R_L=100\Omega$) | |
| | PR49MF11NSZ | | | | 800 | 1 | MAX.10 | |
| | PR39MF11NSZ | PR39MF11YSZ | | | 600 | 1 | MAX.10 | |
| Model No. | PR39MF12NSZ | PR39MF12YSZ | | | 000 | 2 | MAX.5 | |
| | PR29MF11NSZ | | | | 400 | 1 | MAX.10 | |
| | PR29MF12NSZ | | | | 400 | 2 | MAX.5 | |

Please contact a local SHARP sales representative to see the actual status of the production.



Fig.1 Forward Current vs. Ambient Temperature

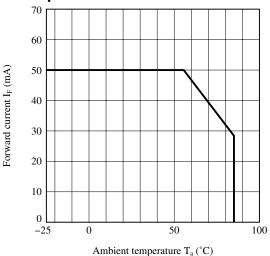


Fig.3-a Forward Current vs.
Forward Voltage (Rank 1)

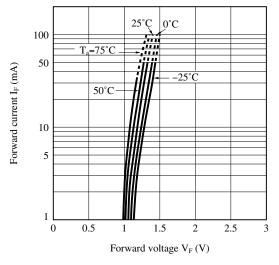


Fig.4-a Minimum Trigger Current vs.

Ambient Temperature (Rank 1)

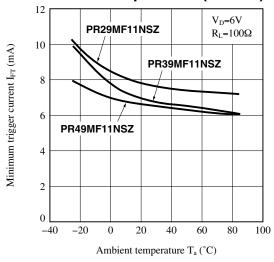


Fig.2 RMS ON-state Current vs.
Ambient Temperature

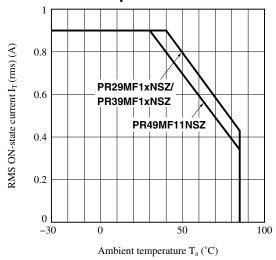


Fig.3-b Forward Current vs.
Forward Voltage (Rank 2)

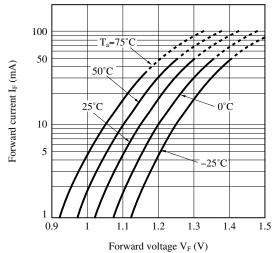


Fig.4-b Minimum Trigger Current vs.

Ambient Temperature (Rank 2)

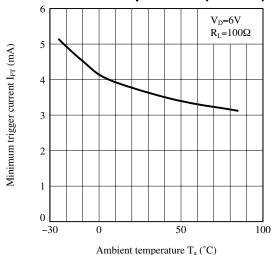




Fig.5 ON-state Voltage vs.
Ambient Temperature

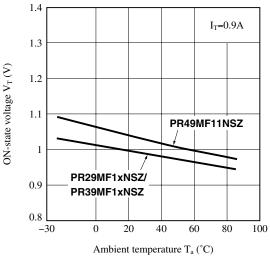


Fig.7 ON-state Current vs. ON-state Voltage

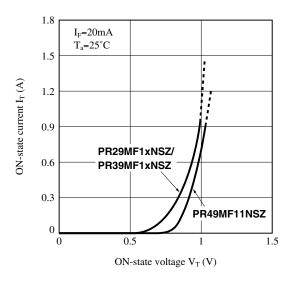


Fig.8-b Turn-on Time vs. Forward Current (Rank 2)

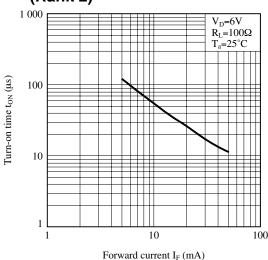


Fig.6 Relative Holding Current vs.
Ambient Temperature

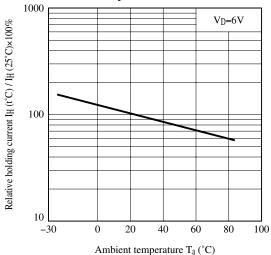
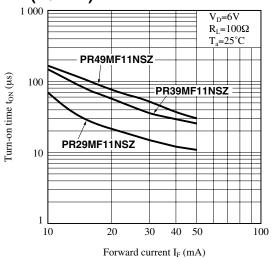


Fig.8-a Turn-on Time vs. Forward Current (Rank 1)



Remarks: Please be aware that all data in the graph are just for reference.



■ Design Considerations

Recommended Operating Conditions

| Parameter | | | | Symbol | Conditions | MIN. | MAX. | Unit |
|-----------|-----------------------|-------------------------|-----------|------------------------|--|------|----------------|---------|
| | Input signal curre | nput signal current Ran | | I (ON) | | 20 | 25 | |
| Input | at ON state | | Rank 2 | $I_F(ON)$ | _ | 10 | 15 | mA |
| | Input signal curre | ent at OFF | F state | I _F (OFF) | _ | 0 | 0.1 | mA |
| | Lood aupply | PR29MF | 1xNSZ | V _{OUT} (rms) | – Locate snubber circuit between output terminals (Cs=0.022μF, Rs=47Ω) | _ | 120 | V mA |
| | Load supply voltage | PR39MF | 1xNSZ | | | | 240 | |
| | | PR49MF | 11NSZ | | | | 300 | |
| Output | | PR29MF | 1xNSZ | Iouт(rms) | | | It(rms)×80%(*) | |
| | Load supply current | PR39MF | 1xNSZ | | | | | |
| | | PR49MF | 11NSZ | | | 100 | | |
| | Frequency | | | f | - | 50 | 60 | Hz |
| Operati | Operating temperature | | T_{opr} | - | -20 | 80 | °C | |

^(*) See Fig.2 about derating curve (I_T(rms) vs. ambient temperature).

Design guide

In order for the SSR to turn off, the triggering current (I_F) must be 0.1mA or less.

In phase control applications or where the SSR is being by a pulse signal, please ensure that the pulse width is a minimum of 1ms.

When the input current (I_F) is below 0.1mA, the output Triac will be in the open circuit mode. However, if the voltage across the Triac, V_D , increases faster than rated dV/dt, the Triac may turn on. To avoid this situation, please incorporate a snubber circuit. Due to the many different types of load that can be driven, we can merely recommend some circuit values to start with : $Cs=0.022\mu F$ and $Rs=47\Omega$. The operation of the SSR and snubber circuit should be tested and if unintentional switching occurs, please adjust the snubber circuit component values accordingly.

When making the transition from On to Off state, a snubber circuit should be used ensure that sudden drops in current are not accompanied by large instantaneous changes in voltage across the Triac.

This fast change in voltage is brought about by the phase difference between current and voltage.

Primarily, this is experienced in driving loads which are inductive such as motors and solenods.

Following the procedure outlined above should provide sufficient results.

Any snubber or Varistor used for the above mentioned scenarios should be located as close to the main output triac as possible.

All pins shall be used by soldering on the board. (Socket and others shall not be used.)

Degradation

In general, the emission of the IRED used in SSR will degrade over time.

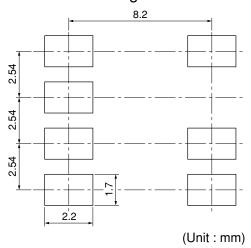
In the case where long term operation and / or constant extreme temperature fluctuations will be applied to the devices, please allow for a worst case scenario of 50% degradation over 5years.

Therefore in order to maintain proper operation, a design implementing these SSRs should provide at least twice the minimum required triggering current from initial operation.

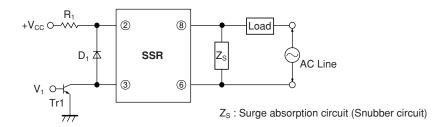


Recommended Foot Print (reference)

SMT Gullwing Lead-form



Standard Circuit



[☆] For additional design assistance, please review our corresponding Optoelectronic Application Notes.



■ Manufacturing Guidelines

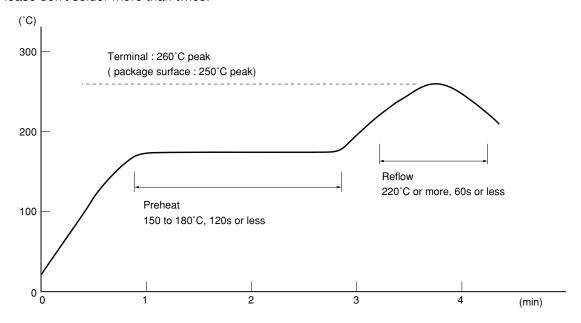
Soldering Method

Reflow Soldering:

Reflow soldering should follow the temperature profile shown below.

Soldering should not exceed the curve of temperature profile and time.

Please don't solder more than twice.



Flow Soldering:

Flow soldering should be completed below 270°C and within 10s.

Preheating is within the bounds of 100 to 150°C and 30 to 80s.

Please don't solder more than twice.

Hand soldering

Hand soldering should be completed within 3s when the point of solder iron is below 400°C.

Please don't solder more than twice.

Other notices

Please test the soldering method in actual condition and make sure the soldering works fine, since the impact on the junction between the device and PCB varies depending on the tooling and soldering conditions.



Cleaning instructions

Solvent cleaning:

Solvent temperature should be 45°C or below. Immersion time should be 3minutes or less.

Ultrasonic cleaning:

The impact on the device varies depending on the size of the cleaning bath, ultrasonic output, cleaning time, size of PCB and mounting method of the device.

Therefore, please make sure the device withstands the ultrasonic cleaning in actual conditions in advance of mass production.

Recommended solvent materials:

Ethyl alcohol, Methyl alcohol and Isopropyl alcohol.

In case the other type of solvent materials are intended to be used, please make sure they work fine in actual using conditions since some materials may erode the packaging resin.

Presence of ODC

This product shall not contain the following materials.

And they are not used in the production process for this device.

Regulation substances: CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methylchloroform)

Specific brominated flame retardants such as the PBBOs and PBBs are not used in this product at all.



■ Package specification

● Sleeve package Through-Hole

Package materials

Sleeve: HIPS (with anti-static material)

Stopper: Styrene-Elastomer

Package method

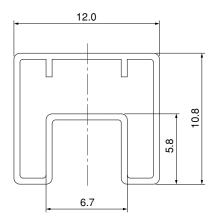
MAX. 50pcs of products shall be packaged in a sleeve.

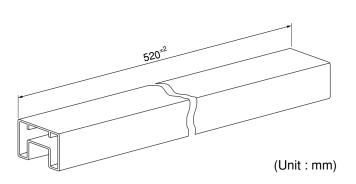
Both ends shall be closed by tabbed and tabless stoppers.

The product shall be arranged in the sleeve with its anode mark on the tabless stopper side.

MAX. 20 sleeves in one case.

Sleeve outline dimensions







Tape and Reel package SMT Gullwing

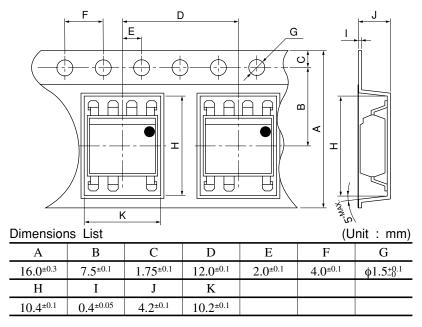
Package materials

Carrier tape: A-PET (with anti-static material)

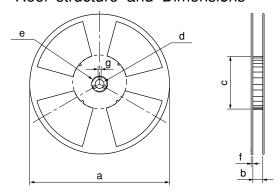
Cover tape: PET (three layer system)

Reel: PS

Carrier tape structure and Dimensions

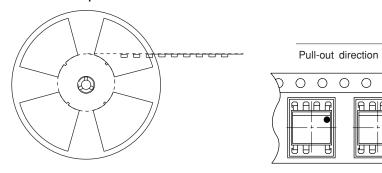


Reel structure and Dimensions



| Dimensio | ns List | (Unit: mm) | | | |
|--------------------|----------------------|----------------|--------------------|--|--|
| a | b | c | d | | |
| 330 | 17.5 ^{±1.5} | 100±1.0 | 13 ^{±0.5} | | |
| e | f | g | | | |
| 23 ^{±1.0} | 2.0 ^{±0.5} | $2.0^{\pm0.5}$ | | | |

Direction of product insertion



[Packing: 1 000pcs/reel]



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 - --- Office automation equipment
 - --- Telecommunication equipment [terminal]
 - --- Test and measurement equipment
 - --- Industrial control
 - --- Audio visual equipment
 - --- Consumer electronics
- (ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection

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- --- Traffic signals
- --- Gas leakage sensor breakers
- --- Alarm equipment
- --- Various safety devices, etc.
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